



Click [here](#) for the 3D model.

General Information

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|----------------|--------------------------------------|
| Series | EDT |
| Dielectric | Aluminum Electrolytic |
| Style | SMD Can |
| Description | Surface Mount, Aluminum Electrolytic |
| RoHS | Yes |
| Lead | V-Chip |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |

Dimensions

| | |
|---|-----------------|
| D | 8mm +/-0.5mm |
| L | 10.2mm +/-0.3mm |
| W | 0.9mm +/-0.2mm |
| F | 0.3mm MAX |
| A | 8.3mm +/-0.2mm |
| B | 8.3mm +/-0.2mm |
| C | 10mm MAX |
| E | 2.9mm +/-0.2mm |
| G | 0.7mm +/-0.2mm |
| P | 3.1mm +/-0.2mm |

Packaging Specifications

| | |
|-----------|-----|
| Packaging | T&R |
|-----------|-----|

Specifications

| | |
|-------------------------|------------------------|
| Capacitance | 47 uF |
| Tolerance | 20% |
| Voltage DC | 35 VDC, 44 VDC (Surge) |
| Temperature Range | -40/+125°C |
| Rated Temperature | 125°C |
| Life | 2000 Hrs |
| Dissipation Factor | 14% |
| Ripple Current | 130 mAmps (120Hz 125C) |
| High Temperature Solder | Yes |
| Leakage Current | 16.5 uA (2min 20°C) |
| Impedance Ratio at -25C | 2 |
| Impedance Ratio at -40C | 3 |